

GENERAL DESCRIPTION

The SGM4T245S is a 4-bit bus transceiver with configurable voltage translation and 3-state outputs. The nAn and nBn are 4-bit data input and output ports, nDIR is the direction control input and nOE is an output enable input. V_{CCA} and V_{CCB} are dual-supply pins. The supply voltage of V_{CCA} and V_{CCB} can range from 1.2V to 5.5V, making the device suitable for bidirectional translating among any of the 1.2V, 1.5V, 1.8V, 2.5V, 3.3V and 5.5V voltage nodes. The nAn, nDIR and nOE pins are referenced to V_{CCA}, and nBn pins are referenced to V_{CCB}.

The direction control (nDIR) input determines the direction of the data flow. The nDIR (active high) enables data from nAn ports to nBn ports. The nDIR (active low) enables data from nBn ports to nAn ports. When the output enable (nOE) input is high, both nAn and nBn ports are disabled, so the buses are effectively isolated.

This device is highly suitable for partial power-down applications using power-off leakage current (I_{OFF}) circuit. When the device is powered down, the current backflow will be prevented from passing through the device.

FEATURES

- V_{CCA} Supply Voltage Range: 1.2V to 5.5V
- V_{CCB} Supply Voltage Range: 1.2V to 5.5V
- Inputs Accept Voltages Higher than the Supply Voltage
- +20mA/-20mA Output Current
- Outputs in High-Impedance State when V_{CCA} or V_{CCB} = 0V
- -40°C to +125°C Operating Temperature Range
- Available in Green TSSOP-16 and TQFN-2.6×1.8-16L Packages

APPLICATIONS

Personal Electronic
Industrial Equipment
Enterprise Infrastructures
Telecom Equipment

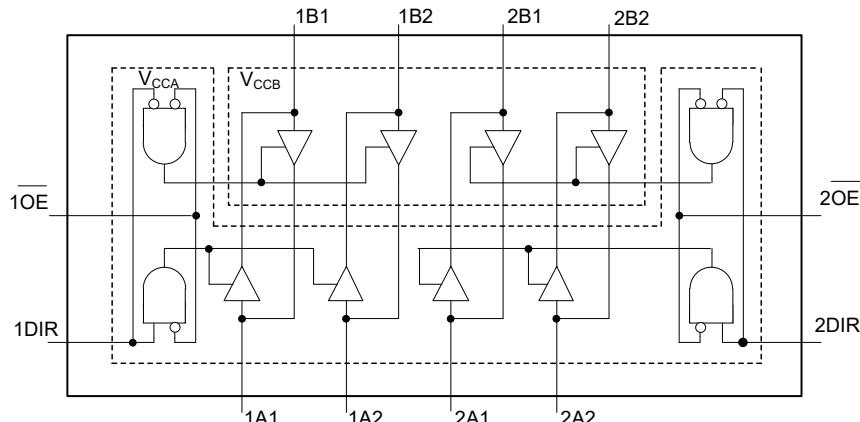
FUNCTION TABLE

CONTROL INPUTS		INPUT/OUTPUT	
nOE	nDIR	nAn	nBn
L	L	nAn = nBn	Inputs
L	H	Inputs	nBn = nAn
H	X	Z	Z

H = High Voltage Level; L = Low Voltage Level

Z = High-Impedance State; X = Don't Care

LOGIC DIAGRAM



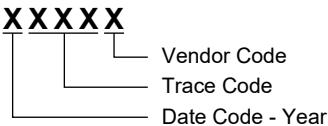
4-Bit Dual-Supply Bus Transceiver with SGM4T245S Configurable Voltage Translation and 3-State Outputs

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM4T245S	TSSOP-16	-40°C to +125°C	SGM4T245SXTS16G/TR	SGM06L XTS16 XXXXX	Tape and Reel, 4000
	TQFN-2.6×1.8-16L	-40°C to +125°C	SGM4T245SXTQA16G/TR	06K XXXXX	Tape and Reel, 3000

MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Supply Voltage Range, V _{CCA}	-0.3V to 6.0V
Supply Voltage Range, V _{CCB}	-0.3V to 6.0V
Input Voltage Range, V _I ⁽²⁾	-0.3V to 6.0V
Output Voltage Range, V _O ⁽²⁾	
3-State Mode	-0.3V to 6.0V
High-State or Low-State	
A Ports	-0.3V to MIN(6.0V, V _{CCA} + 0.3V)
B Ports	-0.3V to MIN(6.0V, V _{CCB} + 0.3V)
Input Clamp Current, I _{IK} (V _I < 0V)	-70mA
Output Clamp Current, I _{OK} (V _O < 0V)	-70mA
Continuous Output Current, I _O	±70mA
Continuous Output Current (V _{CCA} , V _{CCB} or GND).....	±100mA
Junction Temperature ⁽³⁾	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10s).....	+260°C
ESD Susceptibility	
HBM.....	2000V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Supply Voltage Range, V _{CCA}	1.2V to 5.5V
Supply Voltage Range, V _{CCB}	1.2V to 5.5V
Input Voltage Range, V _I	0V to 5.5V
Output Voltage Range, V _O	
3-State Mode	0V to 5.5V
High-State or Low-State	
A Ports	0V to V _{CCA}
B Ports	0V to V _{CCB}
Operating Temperature Range	-40°C to +125°C

OVERSTRESS CAUTION

- Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.
- The input and output voltage ratings may be exceeded if the input and output clamp current ratings are observed.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

ESD SENSITIVITY CAUTION

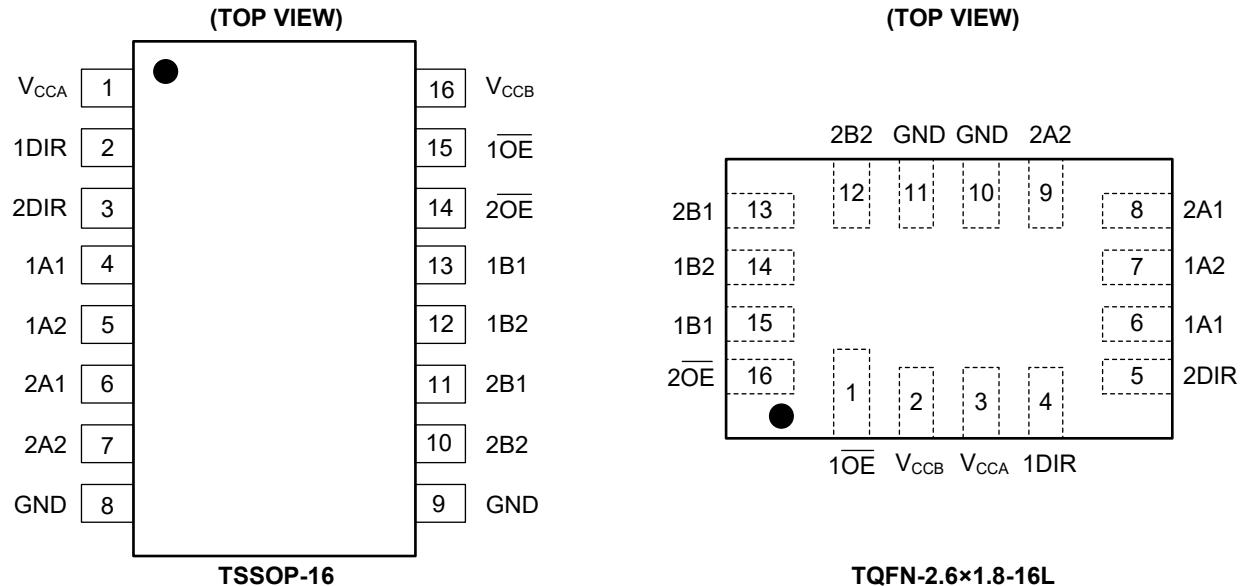
This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

4-Bit Dual-Supply Bus Transceiver with Configurable Voltage Translation and 3-State Outputs

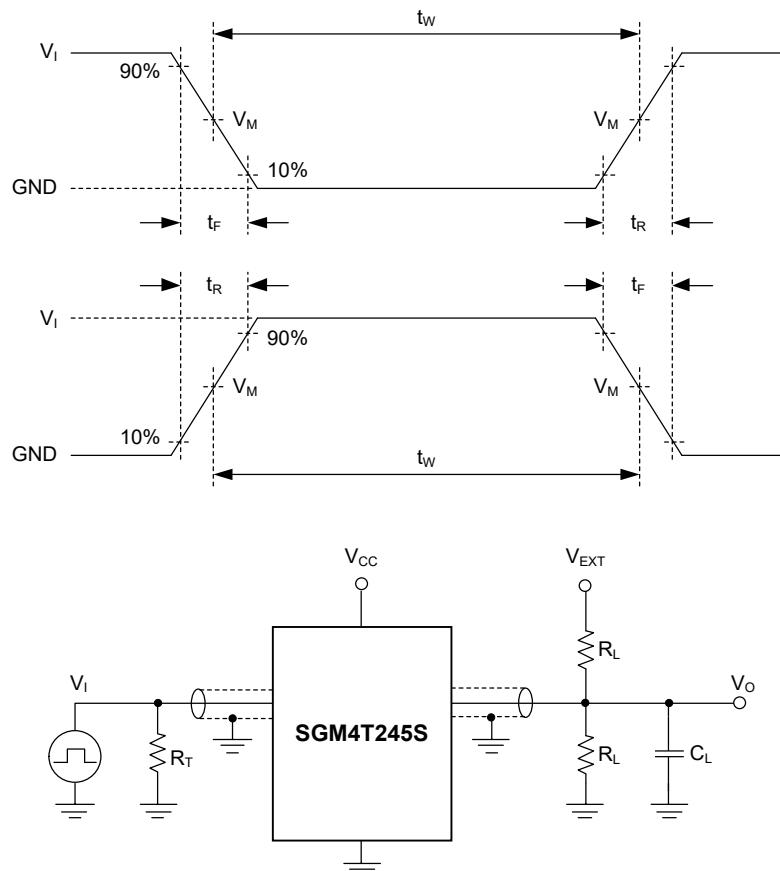
PIN CONFIGURATIONS



PIN DESCRIPTION

PIN		NAME	FUNCTION
TSSOP-16	TQFN-2.6x1.8-16L		
1	3	V _{CCA}	Supply Voltage V _{CCA} . The nAn, nDIR and nOE signals are referenced to V _{CCA} .
2, 3	4, 5	1DIR, 2DIR	Direction Control Inputs.
4, 5	6, 7	1A1, 1A2	Data Inputs/Outputs.
6, 7	8, 9	2A1, 2A2	Data Inputs/Outputs.
8, 9	10, 11	GND	Ground.
11, 10	13, 12	2B1, 2B2	Data Inputs/Outputs.
13, 12	15, 14	1B1, 1B2	Data Inputs/Outputs.
15, 14	16, 1	1OE, 2OE	Output Enable Inputs (Active Low).
16	2	V _{CCB}	Supply Voltage V _{CCB} . The nBn signals are referenced to V _{CCB}

TEST CIRCUIT



Test conditions are given in Table 1.

Definitions for test circuit:

R_L : Load resistance.

C_L : Load capacitance (includes jig and probe).

R_T : Termination resistance (equals to output impedance Z_O of the pulse generator).

V_{EXT} : External voltage is used to measure switching time.

Figure 1. Test Circuit for Measuring Switching Times

Table 1. Test Conditions

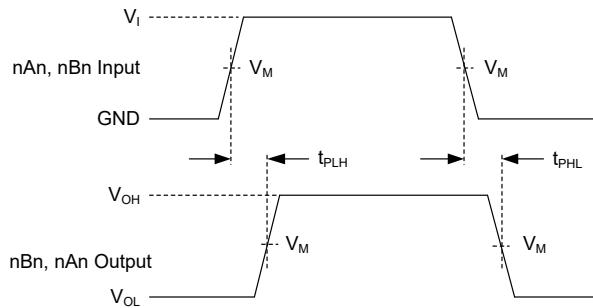
SUPPLY VOLTAGE	INPUT		LOAD		V_{EXT}		
V_{CC_A}, V_{CC_B}	$V_I^{(1)}$	$\Delta t/\Delta V$	C_L	R_L	t_{PLH}, t_{PHL}	t_{PZH}, t_{PHZ}	$t_{PZL}, t_{PLZ}^{(2)}$
1.2V to 5.5V	V_{CCI}	$\leq 1.0\text{ns/V}$	15pF	2k Ω	Open	GND	$2 \times V_{CCO}$

NOTES:

1. V_{CCI} is the supply voltage associated with the data input ports.

2. V_{CCO} is the supply voltage associated with the data output ports.

WAVEFORMS

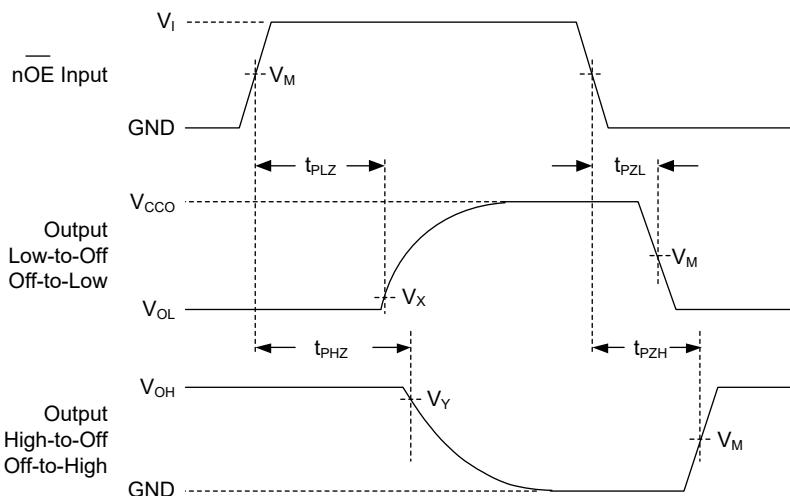


Test conditions are given in Table 1.

Measurement points are given in Table 2.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 2. Input (nAn, nBn) to Output (nBn, nAn) Propagation Delay Times



Test conditions are given in Table 1.

Measurement points are given in Table 2.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 3. Enable and Disable Times

Table 2. Measurement Points

SUPPLY VOLTAGE	INPUT ⁽¹⁾		OUTPUT		
	V_{CCI}	V_M ⁽²⁾	V_M ⁽³⁾	V_X	V_Y
1.2V	V_{CCI}	$0.5 \times V_{CCI}$	$0.5 \times V_{CCO}$	$V_{OL} + 0.1V$	$V_{OH} - 0.1V$
$1.5V \pm 0.1V$	V_{CCI}	$0.5 \times V_{CCI}$	$0.5 \times V_{CCO}$	$V_{OL} + 0.1V$	$V_{OH} - 0.1V$
$1.8V \pm 0.15V$	V_{CCI}	$0.5 \times V_{CCI}$	$0.5 \times V_{CCO}$	$V_{OL} + 0.15V$	$V_{OH} - 0.15V$
$2.5V \pm 0.2V$	V_{CCI}	$0.5 \times V_{CCI}$	$0.5 \times V_{CCO}$	$V_{OL} + 0.15V$	$V_{OH} - 0.15V$
$3.3V \pm 0.3V$	V_{CCI}	$0.5 \times V_{CCI}$	$0.5 \times V_{CCO}$	$V_{OL} + 0.3V$	$V_{OH} - 0.3V$
$5.0V \pm 0.5V$	V_{CCI}	$0.5 \times V_{CCI}$	$0.5 \times V_{CCO}$	$V_{OL} + 0.5V$	$V_{OH} - 0.5V$

NOTES:

1. V_{CCI} is the supply voltage associated with the data input ports.
2. The measurement points should be V_{IH} or V_{IL} when $\Delta t/\Delta V > 1.0\text{ns}/V$.
3. V_{CCO} is the supply voltage associated with the data output ports.

SGM4T245S 4-Bit Dual-Supply Bus Transceiver with Configurable Voltage Translation and 3-State Outputs

REVISION HISTORY

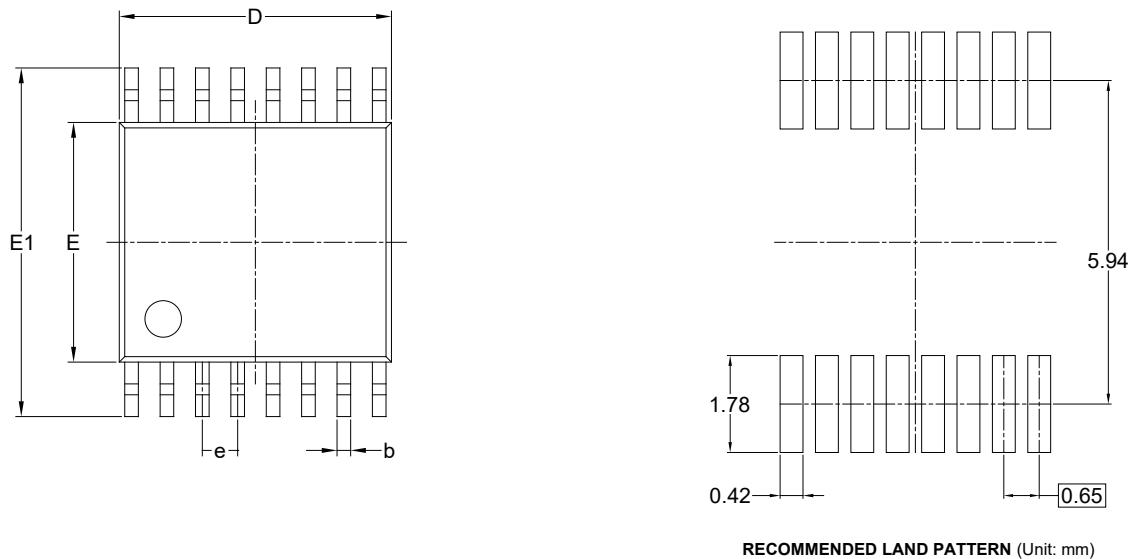
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (DECEMBER 2023) to REV.A	Page
Changed from product preview to production data.....	All

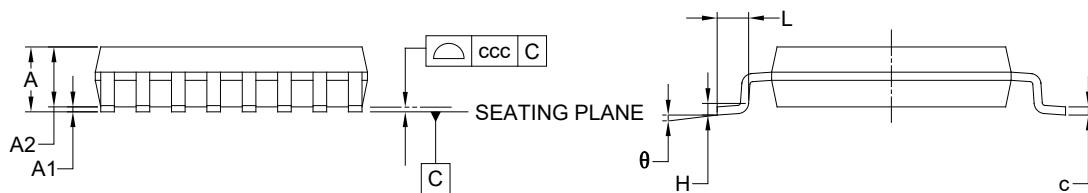
PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

TSSOP-16



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		
	MIN	MOD	MAX
A	-	-	1.200
A1	0.050	-	0.150
A2	0.800	-	1.050
b	0.190	-	0.300
c	0.090	-	0.200
D	4.860	-	5.100
E	4.300	-	4.500
E1	6.200	-	6.600
e	0.650 BSC		
L	0.450	-	0.750
H	0.250 TYP		
θ	0°	-	8°
ccc	0.100		

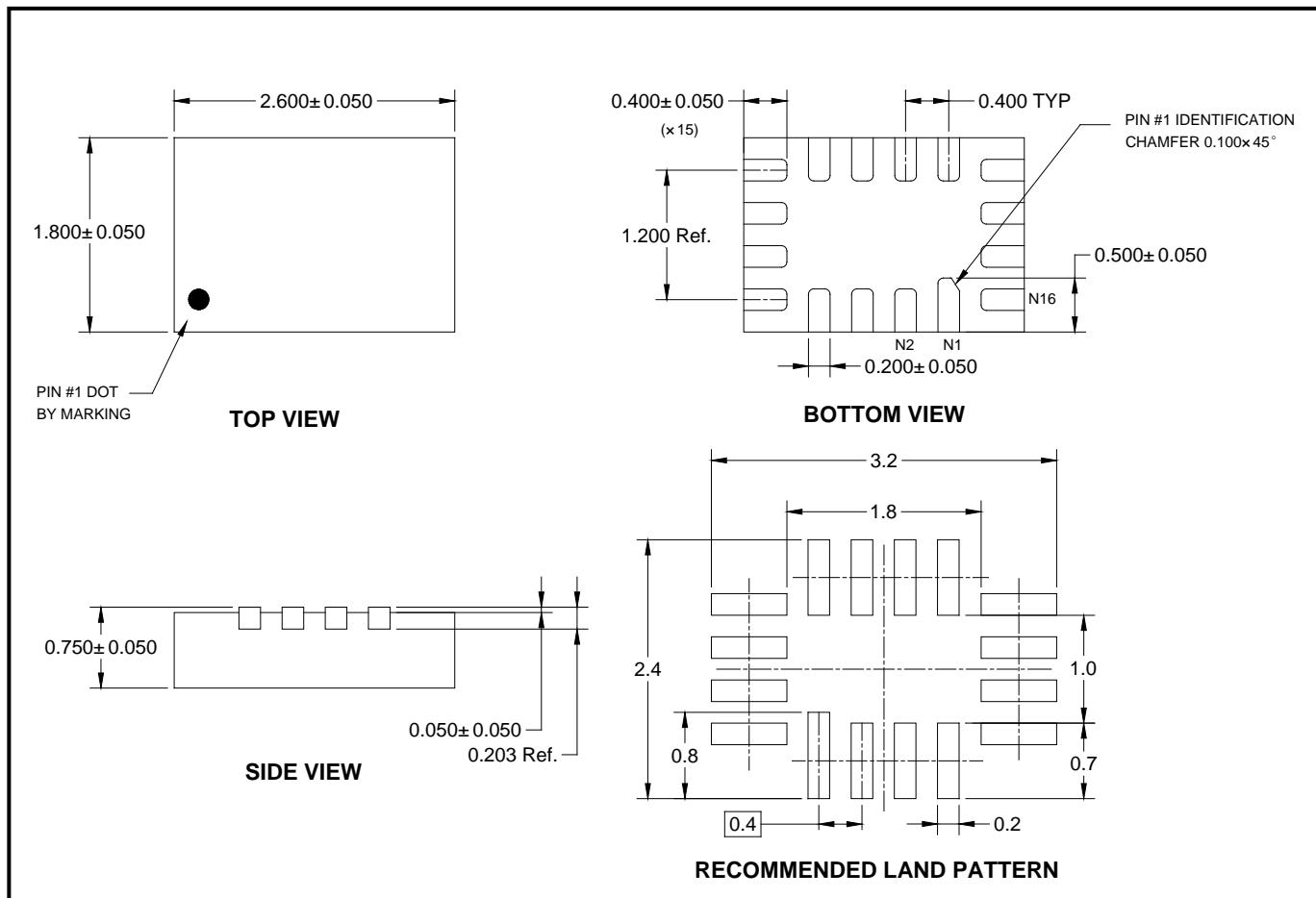
NOTES:

1. This drawing is subject to change without notice.
2. The dimensions do not include mold flashes, protrusions or gate burrs.
3. Reference JEDEC MO-153.

PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

TQFN-2.6x1.8-16L



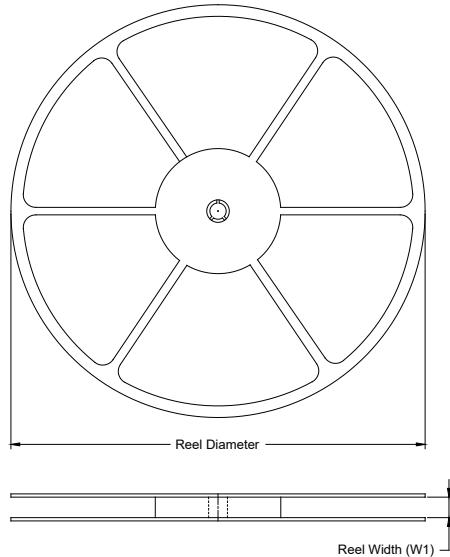
NOTES:

1. All linear dimensions are in millimeters.
2. This drawing is subject to change without notice.

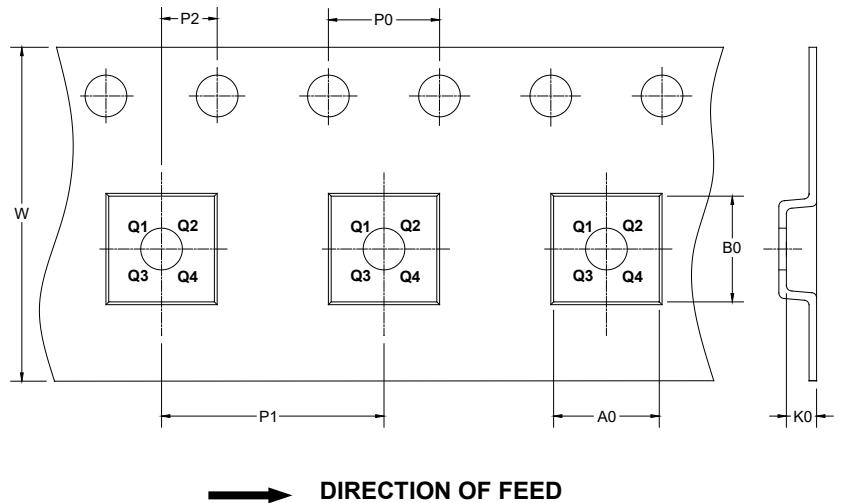
PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



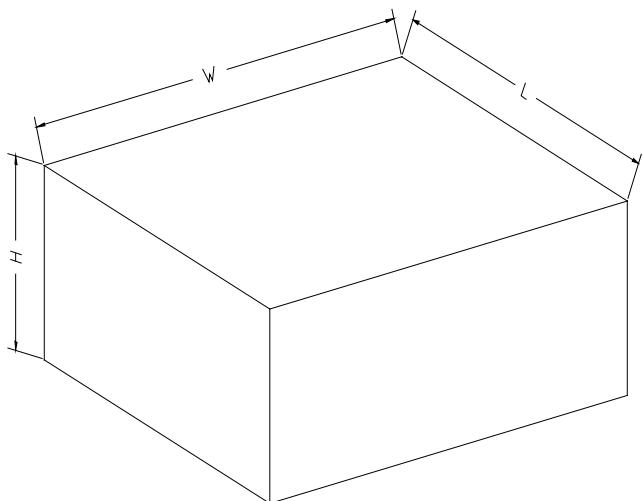
NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TSSOP-16	13"	12.4	6.80	5.40	1.50	4.0	8.0	2.0	12.0	Q1
TQFN-2.6×1.8-16L	7"	9"	2.01	2.81	0.93	4.0	4.0	2.0	8.0	Q1

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18
13"	386	280	370	5

DD0002